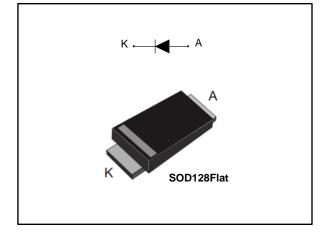


STPS3H100AFY

Automotive high voltage power Schottky rectifier

Datasheet - production data



Description

This high voltage Schottky barrier rectifier device is packaged in SOD128Flat and designed for high frequency miniature switched mode power supplies and for board DC to DC converters for automotive applications.

Symbol	Value
lf(AV)	3 A
Vrrm	100 V
T _i (max.)	175 °C
V⊧(typ.)	0.57 V

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche specification
- ECOPACK[®] compliant component
- AEC-Q101
- PPAP capable
- V_{RRM} guaranteed from -40 to +175 °C

June 2016

DocID029434 Rev 1

This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Pa	Value	Unit	
Vrrm	Repetitive peak reverse voltage (T_j = -40 °C to +175 °C)		100	V
I _{F(AV)}	Average forward current $T_L = 140 \text{ °C}, \delta = 0.5$, square pulse		3	А
IFSM	Surge non repetitive forward current	t _p = 10 ms sinusoidal	75	А
Parm	Repetitive peak avalanche power $t_p = 10 \ \mu s, \ T_j = 125 \ ^\circ C$		172	W
T _{stg}	Storage temperature range		-65 to +175	°C
Tj	Operating junction temperature	-40 to +175	°C	

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Symbol	Parameter	Max. value	Unit
Rth(j-l)	Junction to lead	16	°C/W

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = 100 V	-		1.5	μA
		T _j = 125 °C		-	0.6	1.7	mA
VF ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 3 A	-		0.76	v
		T _j = 125 °C		-	0.57	0.61	
		T _j = 25 °C	IF = 6 A	-		0.84	V
		T _j = 125 °C		-	0.64	0.68	

Table 4: Static electrical characteristics

Notes:

$$\label{eq:powerset} \begin{split} & \mbox{$^{(1)}$Pulse test: $t_p=5$ ms, $\delta<2\%$} \\ & \mbox{$^{(2)}$Pulse test: $t_p=380$ µs, $\delta<2\%$} \end{split}$$

To evaluate the conduction losses, use the following equation:

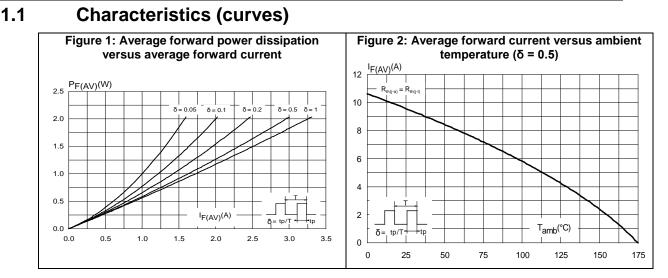
 $P = 0.54 \text{ x } I_{F(AV)} + 0.023 \text{ x } I_{F^{2}(RMS)}$

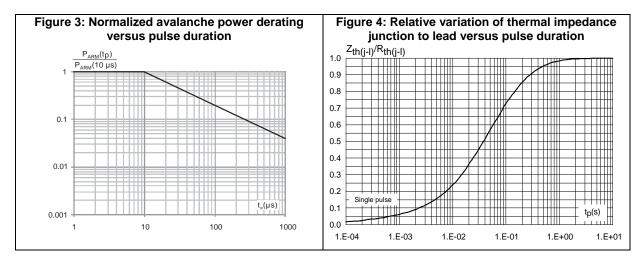


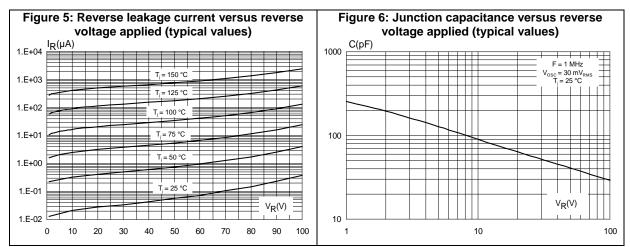


STPS3H100AFY

Characteristics



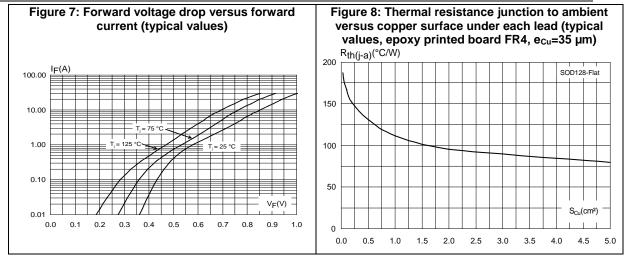




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Characteristics

STPS3H100AFY





2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Epoxy meets UL94, V0
- Lead-free package

2.1 SOD128Flat package information

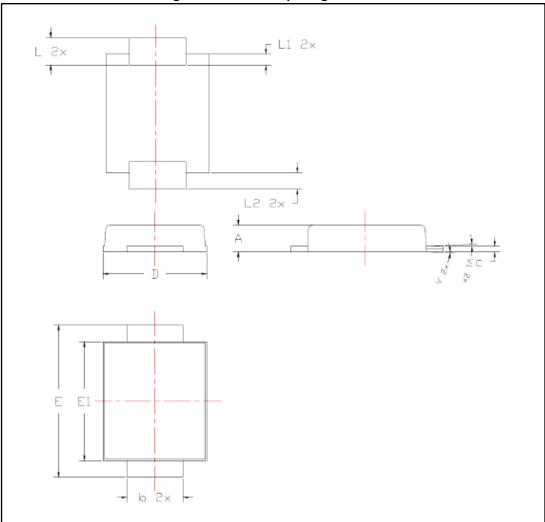


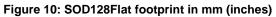
Figure 9: SOD128Flat package outline

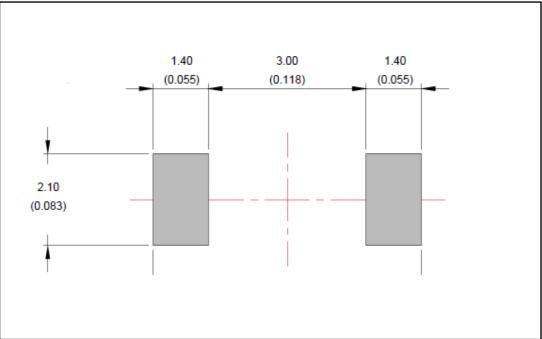


Package information

STPS3H100AFY

	Table 5: SOD128Flat package mechanical data					
		Dimensions				
Ref.	Millin	Millimeters		hes		
	Min.	Max.	Min.	Max.		
А	0.93	1.03	0.037	0.041		
b	1.69	1.81	0.067	0.071		
С	0.10	0.22	0.004	0.009		
D	2.30	2.50	0.091	0.098		
E	4.60	4.80	0.181	0.189		
E1	3.70	3.90	0.146	0.154		
L	0.55	0.85	0.026	0.033		
L1	0.30	0.30 typ.		2 typ.		
L2	0.45	0.45 typ.		З typ.		







3 Ordering information

Table 6: Ordering information					
Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS3H100AFY	3H100Y	SOD128Flat	26.4 mg	3000	Tape and reel

4 Revision history

Table 7:	Document	revision	historv
1001011	Doounion	10101011	motory

Date	Revision	Changes
09-Jun-2016	1	Initial release.



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